

ENGINEERING DEPT.		PRODUCT SPECIFICATION	SPEC.NO.:	SPCI095C
REVISIONS:	ECNT114299	For CI07 Latch Type Connector	PAGE:	1/4

1. SCOPE:

This specification contains the test requirement of subject connectors when tested under the condition and procedure with terminals crimped on the specified maximum size wire

2. APPLICABLE STANDARDS:

MIL - STD - 202	Methods for test of connectors for electronic equipment
MIL - STD - 1344	Test methods for electrical connectors
J-STD-020	Resistance to soldering Temperature for through hole Mounted Devices
SS-00254	Test methods for electronic components ,LEAD-FREE soldering Part design standards

3. APPLICABLE SERIES NO.: Housing: CI0702SL0**-NH
Header: CI0702M1*R*-NH (Halogen-Free)
Terminal: CI07T021PE0 (For AWG #22~#26)
CI07T011PE0 (For AWG #28~#30)

4. SHAPE, CONSTRUCTION AND DIMENSIONS

See attached drawings

5. MATERIALS

See attached drawings

6. ACCOMMODATED P.C.BOARD

6.1 P.C. Board Layout: See attached drawings



REVIEWED : Eisley APPROVED : Eisley VERIFIED : Clark .

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7. ELECTRICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
7.1	Rated current and voltage		4A (AWG #22) , 350V AC/DC
7.2	Contact resistance	Dry circuit of DC 20mV max. , 100mA max., Wire resistance shall be removed from the measured value.	Less than 10 mΩ
7.3	Dielectric strength	When applied AC 1700 V 1 minute between adjacent terminal	No Breakdown
7.4	Insulation resistance	When applied DC 500 V between adjacent terminal or ground	More than 1000 MΩ

8. MECHANICAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT	
8.1	Wire size	Specified wire size	Accepts AWG#22-#30	
8.2	Terminal crimp strength	When crimped AWG#22 size wire	More than 5.0 kgf.	
		When crimped AWG#24 size wire	More than 3.0kgf	
		When crimped AWG#26 size wire	More than 2.0 kgf	
		When crimped AWG#28 size wire	More than 1.3 kgf	
		When crimped AWG#30 size wire	More than 0.8 kgf	
8.3	Terminal insertion force	Insertion speed 25± 3 mm per minute into housing	Less than 0.6 Kgf	
8.4	Terminal retaining force in insulator	Retention speed 25± 3 mm per minute from Housing	More than 0.7 kgf	
8.5	Pin retention force in Board mount Header	Push Pin from insulator base at speed 25± 3 mm per minute	More than 0.4 kgf	
8.6	Single contact insertion force	Measure force to insertion using mating pin at speed 25± 3 mm per minute	600 gram max.	
8.7	Single contact withdrawal force	Measure force to withdrawal using mating pin at speed 25± 3 mm per minute	50 gram min.	
8.8	Mating and Unmating force(Remove Locking Ramp)	Speed 25± 3 mm per minute	Mating (Max.)	Unmating (Min.)
			2.0 kgf	0.2 kgf
8.9	Latch Type force	Speed 25± 3 mm per minute	More than 2.0 kgf	
8.10	Durability	Connector shall be subjected to 30 cycles of insertion and withdrawal	Contact resistance: Less than twice of initial	

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9. ENVIRONMENTAL PERFORMANCE:

	ITEM	TEST CONDITION	REQUIREMENT
9.1	Temperature rise	Then carried the rated current	30°C max.
9.2	Vibration	1.5 mm 10-55-10 HZ/minute each 2 hours for X, Y and Z directions	Appearance: No damage Discontinuity: 1 micro second max.
9.3	Heat aging	85± 2°C, 96 hours	No damage
9.4	Humidity	40± 2°C, 90-95% RH, 96 hours measurement must be taken within 30 min. after tested	Appearance: No damage Contact resistance: Less than twice of initial Dielectric strength: To pass para 7-3
9.5	Temperature cycling	One cycle consists of : (1) -55 ⁺⁰ ₋₃ °C , 30 min. (2) Room temp. 10-15 min. (3) 85 ⁺³ ₋₀ °C , 30 min. (4) Room temp. 10-15 min. Total cycle: 5 cycle	Appearance: No damage Contact resistance: Less than twice of initial
9.6	Salt spray	Temperature: 35± 3°C Solution: 5± 1% Spray time: 48± 4 hours Measurement must be taken after water rinse	Appearance: No damage Contact resistance: Less than twice of initial
9.7	Solder ability	Soldering time: 3 ± 0.5 second Soldering pot: 245 ± 5°C	Minimum: 90% of immersed area
9.8	Resistance to soldering heat	Refer Reflow temperature profile(11.1)	No damage

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10. AMBIENT TEMPERATURE RANGE: -25 to + 85°

11. Recommended IR Reflow Temperature Profile:

11.1 Using Lead-Free Solder Paste

